



Crack Growth in Hydrous Soda-Lime Silicate Glass

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Stable crack growth was measured for nominal dry and water-bearing (6 wt%) soda-lime silicate glasses in double cantilever beam geometry and combined with DMA studies on the effects of dissolved water on internal friction and glass transition, respectively. In vacuum, a decreased slope of logarithmic crack growth velocity versus stress intensity factor is evident for the hydrous glass in line with an increase of β -relaxation intensity indicating more energy dissipation during fracture. Further, inert crack growth in hydrous glass is found to be divided into sections of different slope, which indicates different water related crack propagation mechanism. In ambient air, a largely extended region II is observed for the hydrous glass, which indicates that crack growth is more sensitive to ambient water.

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Waurischk T, Müller R, Reinsch S, Kiefer P, Deubener J, Balzer R and Behrens H (2020) Crack Growth in Hydrous Soda-Lime Silicate Glass. Front. Mater. 7:66. doi: 10.3389/fmats.2020.00066 Keywords: soda-lime silicate glass, water content, stable crack growth, DCB geometry, stress intensity factor, internal friction

INTRODUCTION

Glass strength and fatigue are controlled by the presence and propagation of surface microcracks (Ciccotti, 2009; Wiederhorn et al., 2013a). Focusing mainly on commercial glasses, crack velocity was studied in liquids (Wiederhorn and Bolz, 1970; Simmons and Freiman, 1981; Gehrke et al., 1987a; Gehrke et al., 1990; Gehrke et al., 1991; Dunning et al., 1994), humid air (Wiederhorn, 1967; Richter, 1983; Evans and Johnson, 1975; Gehrke et al., 1987b; Muraoka and Abe, 1996; Freiman et al., 2009), and vacuum (Pukh et al., 2009; Wiederhorn et al., 1974), where ambient water proved to be the key accelerant for slow crack propagation (Wiederhorn, 1967). Stress corrosion is therefore widely accepted as the underlying mechanism, assuming that water molecules break strained Si-O-Si network bonds at the crack tip into silanol groups (Charles, 1958; Hilling and Charles, 1965; Michalske and Freiman, 1982).

However, more recent studies indicate that crack propagation is affected by other phenomena and that a simple \equiv Si-O-Si \equiv + H₂O reaction (Michalske and Freiman, 1982) is unlikely to be the stress corrosion reaction (Ito and Tomozawa, 1981; Tomozawa, 2007; Ciccotti, 2009; Wiederhorn et al., 2013c). In contrast to Michalske and Freiman (1982) it was found that compressive instead of tensile stress promote glass dissolution at the crack tip (Ito and Tomozawa, 1981). Further, glass dissolution and reprecipitation at different curvature can cause crack tip blunting (Ito and Tomozawa, 1982a). Sodium can be enriched at the fractured glass surface (Langford et al., 1991; Celarie et al., 2007), dissolve into the narrow water film at the crack tip (Wiederhorn, 1967) and cause ion exchange related swelling and compressive stress (Lanford et al., 1979). In fused silica, swelling at the crack tip was also found and attributed to stress-induced water diffusion into the glass surface (Tomozawa, 1996; Fett et al., 2005; Wiederhorn et al., 2013a) as it was previously stated (Nogami and Tomozawa, 1984; Han and Tomozawa, 1991). Water penetration and swelling were later described in Wiederhorn et al. (2013a) explaining why the strength of fused silica fibers is increased by soaking in water as reported in Ito and Tomozawa (1982a).

Alternatively, water-induced toughening can be explained by water induced stress relaxation as found for fused silica, E-glass and soda-lime silicate glass fibers (Lezzi and Tomozawa, 2015; Seaman et al., 2015). These experiments on bend fused silica fibers, held under subcritical tensile stress at low water pressure below T_g , indicate that molecular water can cause stress relaxation as a very mobile species. This conclusion was derived from the surface profiles of the IR reflection peak position at $\approx 1120 \text{ cm}^{-1}$, which indicates structural relaxation, and that of the Si-OH concentration. The latter profile was found to be 10 times less extended than the peak position profile (Lezzi and Tomozawa, 2015).

It is reasonable to assume that stress enhanced water diffusion into the strained silicate network (Nogami and Tomozawa, 1984; Han and Tomozawa, 1991; Wiederhorn et al., 2013b) can change local mechanical properties as well (Tomozawa, 2007). Thus, water is known to influence viscosity (Deubener et al., 2003), hardness (Marsh, 1964; Takata et al., 1982), and elastic moduli (Le Parc et al., 2006; Ito and Tomozawa, 1982b). Water was also proved to increase internal friction as e.g., shown for low water bearing (<0.3 wt%) phosphate (Day and Stevels, 1974), sodium silicate and borate glasses (Day, 1974). More recently, internal friction studies on high water bearing (<8 wt%) soda-lime silicate glasses (Reinsch et al., 2013) and sodium borosilicate glasses (Behrens et al., 2018) demonstrated that water strongly affects the temperature range and the intensity of sub- T_g relaxation.

These water-related effects, however, are difficult to be measured directly at the crack tip as the water influenced region is very limited in size (Wiederhorn et al., 2011). Even for slow crack growth in fused silica, the D₂O penetration depth at halfheight was found to be $\approx 6-8$ nm at an average crack velocity of $4 \cdot 10^{-6}$ m s⁻¹ (Lechenault et al., 2011). These values are slightly larger than those for water in fused silica more previously measured with resonant nuclear reaction analysis at 10^{-7} m s⁻¹ (Han and Tomozawa, 1991).

With this in mind, we tried to mimic the effect of water on mechanical properties and crack propagation by studying high water-bearing glass samples. For this purpose, oxide glasses containing up to 8 wt% water were synthesized by melting at high pressure according to Behrens and Stuke (2003). In this way, water speciation and its influence on glass network structure could be investigated for numerous hydrous glasses including soda-lime-borate, sodium borosilicate (Bauer et al., 2017; Behrens et al., 2018), silicoborate (Balzer et al., 2019a), phosphate (Balzer et al., 2019b), and microscope slide glasses (Kiefer et al., 2019). Analogous studies on other soda-lime glasses have been published previously (Behrens and Stuke, 2003).

Recently, measurements of density, molar volume of water, water speciation, elastic moduli, and hardness of water-bearing microscope slide glasses were reported (Kiefer et al., 2019). The present paper focuses on stable crack growth in ambient air and vacuum as well as on internal friction in these glasses.

EXPERIMENTAL

Glass Synthesis and Glass Transition Temperature

Commercial microscope slide glass (VEB, Ilmenau, Germany) of a previous study (Kiefer et al., 2019) was used. In particular, the sample 0W-MSG0 is the nominal dry glass (water content = 0.039 wt%), whereas the samples 3W-MSG500 and 6W-MSG500 are hydrous glasses, which has been, respectively mixed with nominal 3 and 6 wt% water and remelted in a internal pressure vessel at 500 MPa. Synthesis conditions, determination of the water content and the resulted water speciation are reported in Kiefer et al. (2019). The glass transition temperatures (T_g) are 812 K (0W-MSG0), 598 K (3W-MSG500), and 517 K (6W-MSG500) as measured by means of DTA (\pm 5 K, TAG 24, Setaram, Caluire, France) and following the protocol given in Bauer et al. (2015).

Crack Growth in Double Cantilever Beam Geometry (DCB)

Crack growth measurements were made at room temperature in a self-built double cantilever beam device in ambient air at 20% rh (5600 ppmv), 24% rh (6750 ppmv), 40% rh (11300 ppmv), and in a vacuum of $2.8 \cdot 10^{-3}$ mbar (10^{-5} ppmv). Samples had been prepared with a diamond saw. A narrow groove, 600 µm broad and half of the sample thickness in depth, was cutted along the center line of the top surface to guide the crack. Samples of 60 mm × 22 mm × 1 mm and 30 mm × 17 mm × 2 mm in size were used for nominally dry and hydrous glasses, respectively. The stress intensity factor, K_I , was estimated according to Wiederhorn and Bolz (1970):

$$K_I = \frac{PL}{(wa)^{1/2}b^{3/2}} \left(3.47 + 2.32\frac{b}{L}\right) \tag{1}$$

with P = applied load, L = crack length, 2b = width of the glass slide, w = its thickness, and a is the remaining thickness of the glass slide beneath the groove. Eq. 1 is valid for L/b > 1.5. To ensure a sharp crack tip for DCB measurements, a pre-crack was thermally initiated. Afterward, the load was slightly increased until the crack length has reached $1.5 \cdot b$. For measurements in vacuum, crack initiation and minimum growth were performed in air. Maintaining a small load preventing crack recombination, the DCB chamber was then evacuated. The maximum uncertainty of K_I obtained from repeated experiments on different samples of the same glass was ± 0.05 MPa·m^{0.5}.

The crack length, *L*, was measured with a digital microscope (DinoLite, Digital Microscope) using the software DinoCapture2.0. Below 10^{-4} m s⁻¹, the crack velocity, *v*, was calculated from the time required for certain crack elongation steps. These steps were set to 0.1 and 0.3 mm for $v < \text{and} > 10^{-7}$ m s⁻¹, respectively. Based on the accuracy of crack length ($\Delta L = 9 \ \mu$ m) and time measurement ($\Delta t = 1$ s), the uncertainty of *v* was estimated to $\Delta v \approx 3 \cdot 10^{-6}$ and $9 \cdot 10^{-9}$ m s⁻¹ for $v = 10^{-4}$ and 10^{-7} m s⁻¹, respectively, and error bars would not exceed the symbol size.

Above 10^{-4} m s⁻¹, ν was measured by high frequency (f = 5 kHz) modulation during crack growth according

to Kerkhof (1970); Ullner and Gehrke (1990). When crack propagation is affected by superimposed periodic stress, fracture surfaces exhibit a certain waviness and *v* can be concluded from *f* and the distance between neighbored wave peaks. This distance was measured with light microscopy using the software LEXT OLS (Olympus corporation, Tokyo, Japan) within 2 μ m accuracy. For comparison, $v > 10^{-4}$ m s⁻¹ was recorded with a Bonito high speed camera CL-400 (Allied Vision Technologies GmbH, Stadtroda, Germany) using the software Epix[®] Pixci[®] E8, XCAP V 3.8 (Epix Inc., Buffalo Groove, IL, United States) with a frame rate of up to 13000 fps. Applying these different techniques, *v* could be measured within 10 orders of magnitude.

Crack growth velocity data as a function of the stress intensity were analyzed using the empirical relation (Gehrke et al., 1987b).

$$v = v_0 K_I^n \tag{2}$$

where the limiting velocity v_0 and the crack growth exponent *n* (also called fatigue parameter) are adjustable parameters, which depend on the environmental condition of the DCB experiment and the chemical resistance of the glass, respectively.

Internal Friction (DMA)

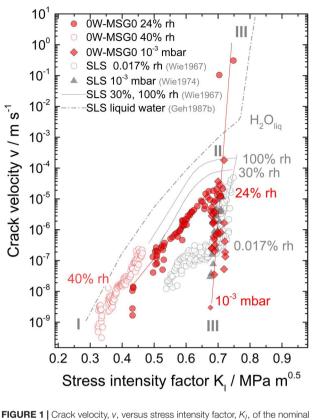
Internal friction was measured with dynamic mechanical analysis (Eplexor 150N and Eplexor 25N, Gabo, Ahlden, Germany) in asymmetric three point bending mode on polished $25 \text{ mm} \times 5 \text{ mm} \times 2 \text{ mm}$ samples. 3 N static and 1.5 N dynamic force components were applied and measured with a 25 N force detector with 0.1% accuracy. Displacement was recorded with an inductive displacement transducer. Force, displacement and phase shift, δ , were recorded in temperature-frequency sweep mode switching between 0.2, 2 and 20 Hz before stepping up by 5 K at ≈ 1.5 K min⁻¹. One frequency cycle took ≈ 13 min and the average heating rate was ≈ 0.3 K min⁻¹. Results are presented in terms of tand versus temperature in 5 K accuracy. OriginPro2015 (OriginLab, 2019) was used for data analysis. Spectra were smoothed averaging over 15 data points. This procedure reduced the scatter of tan δ to $<5 \cdot 10^{-4}$. For clarity, spectra were set zero at their minimum.

RESULTS

Crack Propagation Rates

In order to test the applied experimental procedure, **Figure 1** compares crack velocity data of the dry microscope slide (red symbols) with literature data on similar glasses (gray symbols). Glass compositions and crack growth exponents n (Eq. 2), which represent the slope of *log v* versus log K_I , are listed in **Table 1** for regions I (stress corrosion regime) and III (inert growth) (Ciccotti, 2009).

In region I, v strongly depends on humidity. Thus, log $v(K_I)$ shifts to lower K_I by approx. 0.05 MPa m^{0.5} with increasing humidity from 24% rh (full red circles) to 40% rh (red open circles). This shift and the slope of the log $v(K_I)$ -curve well confirm previous literature. Crack arrest at $K_{I0} \approx 0.32$ MPa m^{0.5} is indicated for 40% rh.



(gray, **Table 1**). Red lines are best fits of Eq. 2. Full red circles: 24% rh, open red circles: 40% rh, full red diamonds: 10⁻³ mbar. Gray open circles: Microscope slide glass at 0.017% rh (Wiederhorn, 1967), gray triangles: Microscope slide glass at 10⁻³ mbar (Wiederhorn et al., 1974), solid gray lines: (Wiederhorn, 1967), gray tash-dot curve: Float glass in liquid water (e.g. Gehrke et al., 1987b).

In *region II*, the transition from region I to inert crack growth (region III) appears within a narrow range of K_I exhibiting large data scatter. Nevertheless, a slope is difficult to estimate in sufficent accuracy for this region.

In *region III*, crack growth is too fast to be affected by ambient water or occurs in vacuum. In both cases, inert crack growth is expected. Actually, fast crack growth data measured in air (full red circles, $v > 10^{-4}$ m s⁻¹) of this study coincide well with those measured under vacuum at 10^{-3} mbar (full red diamonds). The slope in region III is very steep ($n_{III}/n_I \approx 9$) and substantial crack extension proceeds in a narrow range of K_I . Although the slope appears slightly larger, measured values of fast crack propagation well confirm previous literature. Summing up, **Figure 1** provides confidence in the applied DCB protocol within 10 orders of magnitude of *v*.

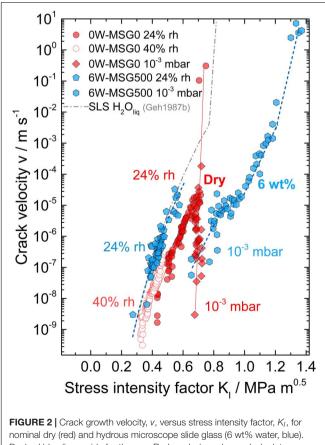
Figure 2 compares crack propagation in the nominal dry microscope slide glass measured in air (red circles) and in vacuum (red diamonds) with that in the hydrous microscope slide glass containing 6 wt% water measured in air (blue circles) and in vacuum (blue diamonds). **Table 1** lists slopes *n*, for different regions of crack propagation.

TABLE 1	Glass composition in mol% and crack	growth exponents for regions Lanc	and III. n_l and n_{lll} are best fits of the data in Figures 1 , 2 with	Eq 2

	SiO₂ 73.2	AI_2O_3	Na₂O 13.3	K₂O 0.2	MgO 6.2	CaO 6.6	H₂O 0.13	nı		n _{III}	
0W-MSG0 (Kiefer et al., 2019)		0.5						(24–40%) rh	$16 \pm 1^{\#}$	(vac.)	148
SLS (Gehrke et al., 1987b)	70.5 ^a	0.3 ^a	13.3 ^a	0.1 ^a	5.9 ^a	9.9 ^a	≈0.1	(H_2O_{liq})	15 ± 1	(nonane)	130 ± 13
SLS (Wiederhorn, 1967)	71.4 ^b	1.2 ^b	13.5 ^b	0.6 ^b	5.9 ^b	7.4 ^b	≈0.1	(10 ⁻² –100%) rh	$17\pm4^{\#}$	(0.017% rh)	88
SLS (Wiederhorn et al., 1974)	71.4	1.2	13.5	0.6	5.9	7.4	≈0.1	-		(vac.)	96
6W-MSG500 (Kiefer et al., 2019)	60.7	0.4	11.0	0.2	5.1	5.5	17.1	(24% rh)	14 ± 3	(vac.)	16, 26, 55

The composition for the hydrous glass 6W-MSG500 is calculated from the composition of the dry glass considering the amount of water measured by means of IR in Kiefer et al. (2019). Data and keys: SLS: soda-lime silicate glass. –: not reported. ^a: as no composition of the float glass in Gehrke et al. (1987b) is given, a float glass composition reported in Deubener et al. (1992) is shown. ^b: taken from Tomozawa (2007). H_2O_{liq} : in liquid water. rh: relative humidity. vac.: in reduced pressure ($\leq 10^{-3}$ mbar). [#]: averaged over different humidity.

In region I (humid air), crack growth in the hydrous glass occurs at lower K_I than those observed for the dry glass. For instance, $v \approx 10^{-7}$ m s⁻¹ measured in air of similar humidity occurs at $K_I \approx 0.50$ and 0.40 MPa m^{0.5} for the dry and the hydrous glass, respectively. Eventhough, the slope of log $v(K_I)$ for the hydrous glass is rather similar to that of the dry glass. It is interesting to note that humidity much stronger promotes the crack growth in the hydrous glass. This effect causes a much broader K_I range of region II, which is shown by the shift of K_I at $v \approx 10^{-7}$ ms⁻¹ down to ≈ 0.40 MPa m^{0.5}, as low



Dashed blue line: guide for the eye. Red symbols and gray dash-dot curve (e.g. Gehrke et al., 1987b) are taken from **Figure 1**. Blue pentagons: 20% rh, blue hexagons: 10^{-3} mbar ($\approx 0.00002\%$ rh).

as measured for float glass in liquid water [gray dash-dot line (Gehrke et al., 1987b)].

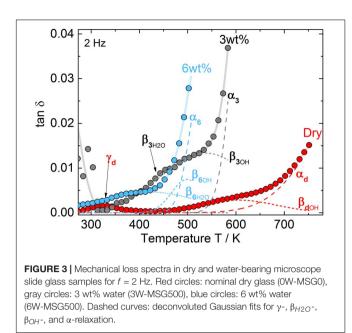
In region III (vacuum), crack growth in the hydrous glass (blue hexagons) considerably differs from that observed for the dry glass (red diamonds). Most notably, the slope of $\log v(K_I)$ is significantly decreased and, since slow crack growth $(10^{-7} \text{ ms}^{-1})$ occurs at similar K_I for both glasses, crack growth in the hydrous glass mostly occurs at higher stress intensity. This effect indicates that dissolved water acts as a toughening agent, at least for $v > 10^{-7}$ m s⁻¹. Moreover, the graph of log $v(K_I)$ can be devided into sections of different slope. Thus, $n_{III} \approx 16$, 26 and 55 occurs for $v \approx 10^{-7} - 10^{-5}$ m s⁻¹, $v \approx 10^{-5} - 10^{-3}$ m s⁻¹ and > 3.10⁻³ m s⁻¹, respectively (**Table 1**). The maximum slope at $v > 10^{-3}$ m s^{-1} is slightly lower than that observed in Gehrke et al. (1987b) for float glass in liquid water. The kink at $v \approx 3 \cdot 10^{-3}$ m s⁻¹, however, coincides with that reported in Gehrke et al. (1987b) (gray dash-dot curve), where inert crack growth is reached. This similarity and different slopes, which might indicate different crack growth mechanisms, make it questionable to assign all sections to the inert crack growth (region III).

DMA

Mechanical loss spectra for different water-bearing glasses obtained by dynamic mechanical analysis are shown in **Figure 3**. Fitted curve parameters are given in **Table 2**. According to Brueckner (1964), three different relaxation peaks can appear. α -relaxation at high temperature (long dashed curves) is caused by network relaxation phenomena, e.g., related to viscosity. Its maximum temperature reflects the frequency dependency of glass transition and can not be approached closer than 20 K during the DMA experiment in order to avoid a change of sample geometry. β -relaxation peaks at medium temperature (short dashed curves) are caused by complex regional co-operative movements of alkali and alkaline earth or water ions whereas γ -relaxation peaks at low temperature (arrow) relate to local alkali movements, i.e., Na⁺ jumps.

For the dry glass, a weak γ -relaxation peak at 329 K (γ_d , arrow) and a weak β -relaxation at 605 K (β_{dOH}) are evident. Above 700 K, α -relaxation dominates.

For the glass containing 3 wt% water, a strong temperature decrease of α -relaxation is evident. This effect resembles the decrease in T_g measured with DTA. Further, a pronounced β -relaxation peak, shifted to 537 K, occurs (β_{3OH}). A closer look also reveals a small secondary β -relaxation peak at 441 K



(β_{3H2O}, arrow). The explanation of this effect can be based on similar findings reported in Reinsch et al. (2013) on sodalime silicate glass, where two β-relaxation peaks have been attributed to molecular (β_{H2O}) and dissociated (β_{OH}) water. In fact, as a ratio of dissociated to molecular water [OH]/[H₂O] ≈ 1:1 was detected for the microscope slide glass containing 3 wt% water (Kiefer et al., 2019), a significant amount of molecular water is present. In this sense, the β-relaxation peaks at 537 K and 441 K can be attributed to β_{OH}- and β_{H2O}relaxation peaks, respectively. As expected for samples with increased β-relaxation (Brueckner, 1964), the γ-relaxation peak disappeared. The relaxation peak near 273 K is probably caused by ice formation at the sample holder.

For the glass containing 6 wt% water, the ratio of dissociated to molecular water [OH]/[H₂O] further decreases to 1:2 (Kiefer et al., 2019). Confirming the strong shift of T_g measured by DTA, α -relaxation further shifts to lower *T*. The β_{OH} -relaxation peak also shifts to lower *T* (\approx 500 K) and decreases in intensity. β_{H2O} -relaxation, however, strongly increases in intensity while shifting to 422 K.

DISCUSSION

Crack Growth Exponent in Vacuum

Figure 2 reveals largely different crack propagation behavior of the nominal dry and the hydrous microscope slide glass in vacuum. Most strikingly, a much smaller crack growth exponent $n_{III} < 55$ is evident for the hydrous glass (blue diamonds), wheras $n_{III} \approx 150$ occurs for the dry glass. n_{III} of the hydrous glass is also smaller than those obtained from literature data in region III in other nominal dry silicate glasses ranging between 88 and 130 (**Table 1**).

The significantly lowered value of n_{III} for the hydrous glass indicates more energy dissipation during fracture. Thus, for ideal

TABLE 2 | Parameters of DMA peak analysis.

Glass	Peak temperature (K)			Peak height (tan δ⋅10 ³)			Peak area (K)		
	γ	β _{H2O}	βон	γ	β_{H2O}	β _{OH}	γ	β_{H2O}	β _{ОН}
0W-MSG0	329	-	605	1.49	-	2.84	0.13	-	0.55
3W-MSG500	-	441	537	-	0.79	13.39	-	0.03	3.11
6W-MSG500	-	422	499	-	7.48	4.65	-	1.15	0.60

brittle fracture, linear elastic fracture mechanics predicts a steep curve of log $v(K_I)$ at $K_I = K_{IC}$ depending on tensile stress, σ , Young's modulus, *E*, and the surface energy, γ_S (Griffith, 1921):

$$\frac{K_I^2(L,\sigma)}{E} = 2\gamma_S \tag{3}$$

If crack propagation is complicated by subsidiary energy dissipation, E and γ_S must be treated as a function of time in terms of Eq. 3 since energy dissipation is always related to relaxation phenomena (Ciccotti, 2009). Following this concept, different approaches in literature could show that energy dissipation results in a decrease of n.

(i) Liang and Zhou (1997), introduced a time depending compliance to model crack growth in viscoelastic solids:

$$\frac{1}{E(t)} = \frac{1}{E_1} + \frac{1}{E_2} [1 - \exp(-t/\tau)]$$
(4)

where τ and t denominate relaxation time and the time required for passing the plastic zone length for a given v, respectively. In this approach, which assumes energy dissipation throughout the whole sample body, $E(t) \approx E_1 \cdot (E_2/(E_1 + E_2))$ for slow crack growth or fast relaxation ($\tau \ll t$). It increases to $E(t) \approx E_1$ for fast crack growth or slow relaxation ($\tau \gg t$). As K_I for a certain value of v increases with E according to Eq. 3, this increase of E with vwill reduce n.

Alternatively, (ii) Maugis (1985) proposed Eq. 5 as the stability criterium for crack growth in viscoelastic solids,

$$\frac{K_I^2}{E} = 2\gamma_S[1 + \alpha \Phi(\nu)] \tag{5}$$

where α is a constant depending on temperature, and Φ depends on ν . In his approach, Maugis assumes that kinetic energy terms are negligible, viscous drag is proportional to the surface energy, γ_S , and energy dissipation is restricted to the vicinity of the crack tip. With $\Phi = \nu^m$ and $2E\gamma_S \ll K_I^2$, Eq. 5 gives the empirical power law of slow crack growth (Maugis, 1985):

$$\nu = \left(\frac{1}{2E\gamma_{S}\alpha}\right)^{\frac{1}{m}} K_{I}^{\frac{2}{m}} \tag{6}$$

where 2/m equals *n* in Eq. 2. For larger *m*, Φ (and hence γ_S in Eq. 3) more strongly increases with *v*, which, in turn, decreases *n*.

The above discussion makes it reasonable to assume that the low values of n_{III} in the hydrous glass seen in **Figure 2** indicate that dissolved water promotes energy dissipation during fracture. Such effect would match the well-known influence

of water on viscosity (Deubener et al., 2003) and stress relaxation (Lezzi and Tomozawa, 2015). Similarly, static fatigue studies on differently annealed silica samples show that n, which is also a fatigue parameter, decreases with increasing water content (Han and Tomozawa, 1991; cited in Tomozawa, 2007). Furthermore, the decrease of Knoop hardness of binary soda silicate glasses with increasing water content indicates that dissolved water promotes deformation by plastic flow (Takata et al., 1982).

Confirmingly, Figure 3 could indicate increased internal friction during fracture in the hydrous glass. Thus, increased mechanical loss at room temperature can be expected from the temperature decrease of α - and β -relaxation and from the intensity increase of β -relaxation. Note that β -relaxation in the 6 wt% water-bearing glass is dominated by water molecules due to the given water speciation ratio $[OH]/[H_2O] \approx 1:2$ (Kiefer et al., 2019). Water molecules have been discussed in Lezzi and Tomozawa (2015) as a very mobile species causing structure relaxation more rapidly than silanol formation. The large mobility of molecular water is already known from diffusion studies in fused silica (Tomozawa et al., 1994). A large mobility of molecular water in the 6 wt% water-bearing glass is also indicated by the low β_{H2O} -relaxation maximum temperature at \approx 422 K, not far above of the γ -relaxation of sodium at 329 K measured in the dry glass and the increased peak area (Table 2).

Figure 3 further indicates that internal friction in the hydrous glass would largely increase if the crack tip temperature increases during fracture. However, Weichert and Schönert (1973) estimated a moderate tip temperature increase of less than 300 K even assuming rapid crack propagation (sodalime silicate glass, $v = 10^3$ m s⁻¹, heat production $2 \cdot 10^{-3}$ J m^{-2}). Also, Figure 3 merely reflects the global viscoelastic response of the sample whereas energy dissipation is widely assumed to mainly occur in the vicinity of the crack tip. The latter assumption is supported by AFM studies revealing large fluctuations in v and a strong scatter in crack surface curvature in a nanometer scale (Marliere et al., 2003), whereas beyond 10 nm from the crack tip, the material appears fully elastic (Wiederhorn et al., 2011). Since internal friction and energy dissipation during fracture should be based on similar structural relaxation phenomena, however, internal friction and crack propagation data may be compared with each other at least qualitatively.

Different Sections of log $v(K_l)$ for Crack Growth in the Hydrous Glass in Vacuum

It is also worth noting that in contrast to the dry sample, log $v(K_I)$ for crack growth in vacuum in the hydrous sample reveals sections of different slopes (**Table 1**). In terms of section "Crack Growth Exponent in Vacuum," this effect is plausible due to the kinetic nature of energy dissipation. When its relaxation time becomes large compared to the time required for fast crack propagation, log $v(K_I)$ becomes steeper possibly causing a kink. This effect is inherently involved in Eq. 4 and also discussed by Maugis (1985) in terms of limiting crack speeds for certain slope

segments. Therefore, *n* generally tends to increase with v (or K_I) as it is shown in **Figure 2**.

The first slope section, exhibiting the lowest slope of log $v(K_I)$ in Figure 2 (n = 16), is limited by a shoulder at $v \approx$ 10^{-5} m s⁻¹ beyond which the slope increases to n = 26. The crack velocity range of this shoulder seems to resemble that of region II for the nominal dry glass in ambient air, where it indicates the kinetic transition between water affected and water-independent crack propagation. Since this transition is even caused by trace amounts of water (Ciccotti, 2009), the similarity between the shoulders for the dry and hydrous glass seen in Figure 2 might indicate similar underlying mechanisms. However, the shoulder at 10^{-3} mbar should occur at lower v. This is indicated by Figure 1, where region II for the dry glass shifts to much lower v with decreasing humidity (e.g., shifting down to $v = 10^{-7}$ m s⁻¹ for crack growth in 0.017% rh) (Wiederhorn, 1967). At 10^{-3} mbar, this shoulder might fall below the range of v measured in this study. On the other hand, the high concentration of water in the hydrous glass [17 mol% (Kiefer et al., 2019)] makes it reasonable to assume that water readily escapes from the freshly fractured surface increasing the local vapor pressure at the crack tip. This effect might resemble the stress-induced emission of sodium during the fracture of soda-lime silicate glass (Lanford et al., 1979). The resulting micro climate might promote stress corrosion related crack propagation as for the dry glass in ambient air. The resulting shoulder in the hydrous glass would thus represent the kinetic limit of the this effect. The similar slopes n_I for region I in the dry and n_{III} for the first slope section in the hydrous glass in vacuum of 16 (Table 1), may also indicate a similar stress corrosion based mechanism. In this case, it would be difficult to apply the term "inert crack growth" or "region III" for this slope section.

The second slope section, exhibiting a slope of n = 26(Figure 2), is limited by a kink at $v \approx 3 \cdot 10^{-3}$ m s⁻¹ beyond which the slope increases to 55. It is interesting to note that this kink resembles the one found by Gehrke et al. (1987b) for crack growth in float glass measured in liquid water. In this case, the limiting effect of (ambient) water transport to the crack tip can be assumed to reach its minimum influence. For crack propagation in the hydrous glass measured in vacuum, however, this explanation seems questionable. Remaining traces of ambient water should cause a shoulder at much lower v and, assuming this effect is promoted by the micro climate at the crack tip, would contradict the above given explanation for the shoulder at $\nu \approx 10^{-5}$ m s^{-1}. Instead, the kink could be assumed to reflect the kinetic limit of Si-OH formation at the crack tip according to Michalske and Freiman (1982). This assumption would explain the kink at $v \approx 3 \cdot 10^{-3}$ m s⁻¹ for the dry glass in liquid water as well as why dissolved water can not further promote crack propagation even though 17 mol% (Kiefer et al., 2019) of dissolved water is present in the hydrous glass. This hypothesis would allow to assume that water molecules might still diffuse toward the crack tip causing energy dissipation. This might also explain the fact that the slope of log $v(K_I)$ above $v \approx 10^{-3}$ m s⁻¹ is smaller for the hydrous glass than for the dry glass.

As an alternative hypothesis, the shoulder at $\nu \approx 10^{-5}$ m s⁻¹ might be explained as discussed above being related to a micro climate at the crack tip whereas the kink at $\nu \approx 10^{-3}$ m s⁻¹ could reflect the kinetic limit of the diffusion of dissolved water toward the crack tip. This latter mechanism resembles the penetration of ambient water molecules into the glass as discussed for crack propagation in air (Tomozawa, 1996; Fett et al., 2005; Wiederhorn et al., 2013a). This effect seems plausible due to the high concentration of water given in the hydrous glass as well as due to the known effect of tensile stress on water diffusivity (Nogami and Tomozawa, 1984; Han and Tomozawa, 1991; Lechenault et al., 2011; Larché and Voorhees, 1996; Mehrer, 1996; Lechenault et al., 2011).

As a further hypothesis, the shoulder at $v \approx 10^{-5}$ m s⁻¹ and the kink at 10^{-3} m s⁻¹ could, respectively indicate the kinetic limit of diffusion of dissolved molecular water to the crack tip and the Si-OH formation. This interpretation implies that molecular water diffusion to the crack tip is slower than Si-OH-formation. At first glance, this assumption seems to contradict findings reported in Lezzi and Tomozawa (2015). This study shows that molecular water in fused silica can cause stress relaxation more rapidly than Si-OH-formation. A large mobility of molecular water is also indicated by the low peak temperature of $\beta_{\rm H2O}$ in **Figure 3**. It seems possible, however, that Si-OH formation could be largely promoted by high tensile stresses at the crack tip. Furthermore, the low temperature mobility of molecular water in soda-lime silicate glass is expected to be less than that in fused silica as demonstrated in Muller et al. (2005).

In any case, all hypotheses discussed above need more detailed studies to get better understanding of the underlying mechanism. In particular, the crack growth measurement of the hydrous glass shown here are based on two DCB samples of sufficient size and homogeneity to ensure straight and smooth crack growth along the groove. As the slope of log $v(K_I)$ for the hydrous glass (n = 55) is still smaller than that of the dry glass (n = 148, see)Table 1), even at $v \approx 1 \text{ m s}^{-1}$, fractographic studies on fast crack growth might be helpful to reveal the kinetic limit of the related energy dissipation mechanism. Such studies would also be very interesting inasmuch other dissipating mechanism could be expected for rapid crack growth. Thus, Kerkhof (1970) found that high humidity can dalay fast crack growth in soda-lime silicate glass above $v = 10 \text{ ms}^{-1}$ due to the adhesion between the fractured surfaces of sufficiantly narrow cracks. On the other hand, it would be interesting to study slow crack growth for $\nu < 10^{-8}$ m s⁻¹ in the hydrous glass. In this case, however, the applicability of Eq. 1 has to be carefully considered with respect to a possible crack tip blunting promoted by the large amount of dissolved water.

Average Shift of log v(K_I)

As seen from Eq. 3, log $v(K_I)$ will shift right or left along the K_I axis if *E* and γ_S increases or decreases, respectively. If the change in *E* and γ_S is not kinetically affected during fracture, K_I equally shifts for any *v*.

Dissolved water and the resulting decrease of E near the crack tip is discussed as a possible mechanism of stress corrosion (Tomozawa, 2007; Wiederhorn et al., 2013a). In this sense,

significant amounts of water dissolved in the hydrous glass during melting should shift log $v(K_I)$ for the inert crack growth to the left. However, the opposite is shown in **Figure 2**, at least for $v > 10^{-7}$ m s⁻¹, where dissolved water obiously acts as a toughening agent. Furthermore, the effect of dissolved water in the hydrous glass on *E*, seems not enough to explain any strong shift of log $v(K_I)$ in **Figure 2**. Thus, Eq. 3 includes a rather moderate effect ($K_I \sim E^{0.5}$) and almost similar values $E \approx 71$ GPa and 68 GPa were measured for the dry and the hydrous glass in Kiefer et al. (2019), respectively. Confirming this slight decrease in *E*, log $v(K_I)$ of the hydrous glass is slightly shifted to the left with respect to the dry glass for the slowest crack propagation rates in vacuum.

According to Eq. 3, $\log v(K_I)$ can also shift to the left if γ_S is decreased by the presence of water. Such a shift is clearly caused by ambient water. Thus, $v = 10^{-7}$ m s⁻¹ occurs at $K_I \approx 0.40$ and 0.67 MPa m^{0.5} for the hydrous glass in ambient and vacuum conditions, respectively. This shift is stronger than that observed for the dry glass measured in similar conditions. This effect is most vividly seen in **Figure 2** by the strongly extended K_I range of region II for the hydrous glass. This behavior indicates that ambient water is far more effective than water dissolved in the glass bulk during pressure melting. This way, the toughening effect of dissolved water was overcompensated. One possible reason might be an even higher water concentration near the surface as proved in Han and Tomozawa (1991) for the outermost layer of fractured fused silica glass surfaces. Also, more molecular water is expected since water speciation equilibrium cannot be reached at the low temperature and short times available for ambient water to dissolve to the crack near glass region. Nevertheless, *dissolved water* may further decrease γ_S since slow crack growth in the hydrous glass in air occurs at lower K_I as in the dry glass.

SUMMARY

Crack propagation in nominal dry and hydrous microscope slide glasses containing 6 wt% water was studied in double cantilever beam geometry and was backed up with dynamic mechanical analysis and DTA. Water enrichment of hydrous glass has been achieved by high-pressure melting of glass powder - water mixtures at 500 MPa.

For crack growth in vacuum, dissolved water strongly decreases the slope of log $\nu(K_I)$ indicating more energy dissipation during fracture. Thus, although slow crack growth ($\nu = 10^{-7}$ m s⁻¹) is not strongly affected by dissolved water occurring at $K_I \approx 0.7$ MPa m^{0.5} as for the dry glass, fast crack growth ($\nu = 10^1$ m s⁻¹) occurs at $K_I \approx 1.4$ MPa m^{0.5}. Consequently, crack growth in hydrous glass occurs at larger stress intensity factor and dissolved water may be regarded as a toughening agent.

However, in ambient air slow crack growth in the hydrous glass was found to occur at lower stress intensity than in the dry one. $v = 10^{-7} \text{ ms}^{-1}$, e.g., is, respectively reached at $K_I \approx 0.4$ and 0.5 MPa m^{0.5} for the hydrous and the dry glass. Consequently, region II is much more extended for the hydrous glass. This effect

gives clear evidence that ambient water acts as a strong weakening agent overriding the toughening effect of dissolved water.

DATA AVAILABILITY STATEMENT

The raw data supporting the conclusions of this article will be made available by the authors, without undue reservation, to any qualified researcher upon request.

AUTHOR CONTRIBUTIONS

TW and RM wrote the first draft of the manuscript. SR and TW did the experiments and analysis. TW, RM, RB, HB, JD, and PK contributed to the conception and to critical interpretation of data for the work. All authors

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Conflict of Interest: The authors declare that the research was conducted in the absence of any commercial or financial relationships that could be construed as a potential conflict of interest.

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